

APSRP Series

Features

- Metal Alloy Low-Resistance shunt resistor.
- Resistance valu 0.4mΩ.
- Low thermal EMF.
- Low TCR.
- Very low inductance.
- Halogen free, lead free and RoHS compliant.
- AEC-Q200 qualified available.

Applications

- · Power modules.
- Frequency converters.
- Current sensor for power hybrid sources high current for automotive.
- · Lithium battery protection board.

Part Number

<u>APSRP</u> <u>25</u> <u>S</u> <u>6</u> <u>F</u> <u>0M40</u>-X

[1] Series Name: Prosemi Shunt Resistor for Automotive.

(2) Chip Size: 25: 2512;(3) Material: S: CuMnSn.

[4] Power Rating: 6=6W.

[5] Resistance Precision: D:±0.5%; F: ±1%; G: ±2%; J:±5%;

[6] Resistance Code: 0M40: $0.4m\Omega$.

[7] Internal Code: X

Electrical Characteristics

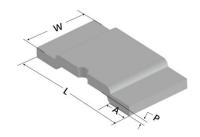
Size	Power Rating at 70°C [*] (W)	Resistance Range(mΩ)**	Element Material	Resistance Tolerance(%)	Operation Temperature Range	Temperature coefficient (ppm/℃)
2512	6	0.4	S	$\pm 0.5; \pm 1;$ $\pm 2; \pm 5;$	-65℃~+170℃	±175

[&]quot;*" : Power at terminal temperature of 70°C.

[&]quot;* *": Development schedule will vary depending on resistance value. Please contact us for resistance values.

APSRP Series

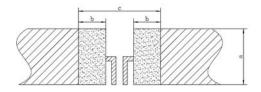
Physical Dimensions



Size	Resistance (mΩ)	L	W	Α	Р	Element Material
2512	0.4	6.4±0.2	3.2 ± 0.2	1.10±0.2	0.45±0.1	S

Unit: mm

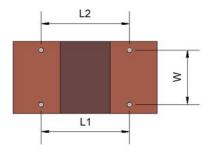
Recommended Solder Pad Layout



Unit: mm

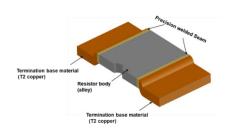
Туре	Resistance (mΩ)	С	а	b
2512	0.4	7	3.4	1.8

Test Point



Type	Resistance (mΩ)	L1(mm)	L2(mm)	W(mm)
2512	0.4	5.6	5.6	1.4

Construction

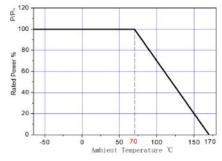




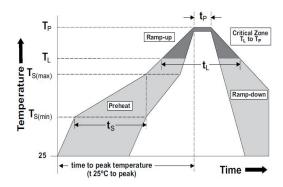
APSRP Series

Power Derating Curve

For resistors operated in ambient temperatures 70°C, power rating shall be derated in according with the curve below:

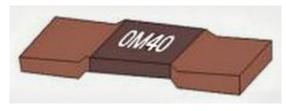


Recommended Solder Curve



Reflow Condition	Reflow Condition			
	- Temperature Min (T _s (min))	150°C		
Pre heat	- Temperature Max (T _s (max))	200°C		
	- Time (Min to Max) (t _s)	60 – 120 secs		
Average ramp up	rate (Liquidus Temp (T _L) to peak	5°C/second max		
T _s (max) to T∟ - Ramp-up Rate	5°C/second max		
Reflow	- Temperature (T _L) (Liquidus)	217°C		
Reliow	- Time (t∟)	60 – 150 seconds		
Pea	k Temperature (T _P)	260°C		
Time within 5°C	of actual peak Temperature (tp)	20 - 40 seconds		
R	amp-down Rate	5°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes Max.		
1	Nave Soldering	Not applicable		
	Hand Soldering	350°C, 5 seconds max.		

Product Marking



2512

- 1. The characters and directions are shown in the figure above:
- 2 Encoding rules: "0M40": $0.4 \text{m} \Omega$;



APSRP Series

Product Characteristics

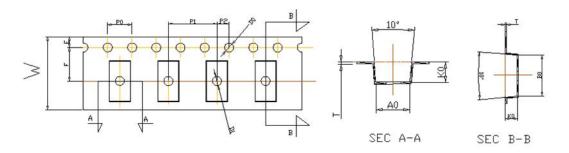
Item	Test condition/ Methods	Limited	Standard
Resistance	Measuring resistance value at room temperature25℃±5℃	Refer to Spec	IEC60115-1 6.1
Temperature Coefficient of Resistance	TCR(ppm/°C) = (R2-R1/R1*(T2-T1))X 10 ⁶ R1: resistance value measured at room temperature (Ω) R2: Resistance measured at 125 ° C (Ω) T1: room temperature (° C) T2: 125 °C	Refer to Spec	MIL-STD-202 Method 304
Short Time Overload	Apply 5 times rated power for 5 seconds, and measure the resistance change after standing for 24 hours.	±1%	IEC 60115-1 8.1
High Temperature Storage	170℃ for 1000 hours, No power	±1%	MIL-STD-202 Method 108
Temperature Cycling	-55°C, (15min)/+150°C(15min), 1000 cycles, transition time less than 1 minute	±1%	JESD22 Method JA-104
Operational life	70℃±2℃, 1000 hours, at rated power 1.5 hours "ON", 0.5 hours "OFF"	±1%	IEC 60115-1 7.1
Mechanical shock	Condition C ,100 g's ,6 msec, 3 mutually perpendicular axes, in 6 directions, three impacts each for a total of 18 times 18 shocks	±1%	MIL-STD-202 Method 213
Vibration	5g's for 20 minutes 12 cycles each of 3 orientations. Test from 10 Hz - 2000 Hz	±1%	MIL-STD-202 Method 204
Resistance to Soldering Heat	Condition K, temperature above 217°C, 60s – 150s	±0.5%	MIL-STD-202 Method 210
Solderability	245±5°C time: 5sec+0/-0.5sec.	≥95%	J-STD-002
Bias Humidity	+85℃, 85%RH, 10% of operating power,1000hours	±1%	MIL-STD-202 Method103
Board Flex	Bending Distance: 2mm,60+5s	±1%	AEC-Q200-005



APSRP Series

Packaging

Tape Dimensions

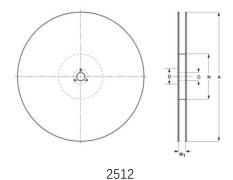


2512

Unit: mm

Series	Туре	A(mm)	B(mm)	E(mm)	F (mm)	W (mm)	T(mm)
2512	0.4m Ω	3.50±0.10	6.70±0.10	1.75±0.10	5.50±0.10	12.00±0.10	0.20±0.05
Series	Туре	P0(mm)	P1(mm)	P2(mm)	D0(mm)	D1(mm)	K0(mm)

Reel Dimensions



Unit: mm

Series	Туре	A (mm)	N (mm)	C (mm)	D (mm)	W1 (mm)
2512	0.4mΩ	178.0±2.0	60.0±1.0	13.5±0.5	21±0.8	13.6±0.5

Quantity of Package

Series	Туре	Quantity(pcs)
2512	$0.4 m\Omega$	2500



APSRP Series

Storage

- The temperature condition must be controlled at 25±5℃, The R.H. must be controlled at 60 ±15% Store in accordance with this requirement, and the validity period is two years after the date of manufacture.
- 2. Please avoid the mentioned harsh environment below when storing to ensure product performance and its' solderability. Places exposed to sea breeze or other corrosive gas, such as Cl₂, H₂S, NH₃, SO₂ and NO₂.
- 3. When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.